

# 1A, 50V - 1000V Surface Mount Rectifier

#### FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Low forward voltage drop
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- DC to DC converter
- Switching mode converters and inverters
- Lighting application
- Snubber
- General purpose

#### **MECHANICAL DATA**

- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.060g (approximately)

KEY PARAMETERS			
PARAMETER	VALUE	UNIT	
I <sub>F</sub>	1	А	
V <sub>RRM</sub>	50 - 1000	V	
I <sub>FSM</sub>	30, 40	А	
T <sub>J MAX</sub>	175	°C	
Package	DO-214AC (SMA)		
Configuration	Single die		





DO-214AC (SMA)



ABSOLUTE MAXIMUM RATINGS (T <sub>A</sub> = 25°C unless otherwise noted)									
PARAMETER	SYMBOL	S1A	S1B	S1D	S1G	S1J	S1K	S1M	UNIT
Marking code on the device		S1A	S1B	S1D	S1G	S1J	S1K	S1M	
Repetitive peak reverse voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Reverse voltage, total rms value	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Forward current	I <sub>F</sub>	1				Α			
Peak forward surge current, 8.3ms single half sine wave superimposed on rated load	I <sub>FSM</sub>	40 30			30	A			
Non-repetitive peak reverse avalanche energy, $I_{AS} = 1A$ , L = 10mH	E <sub>RSM</sub>	5				mJ			
Junction temperature	ТJ	T <sub>J</sub> - 55 to +175				°C			
Storage temperature	T <sub>STG</sub>	- 55 to +175			°C				



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THERMAL PERFORMANCE				
PARAMETER		SYMBOL	ТҮР	UNIT
Junction-to-lead thermal resistance	S1A S1B S1D S1G S1J	R <sub>əJL</sub>	27	°C/W
	S1K S1M		30	°C/W
Junction-to-ambient thermal resistance	S1A S1B S1D S1G S1J	R <sub>eja</sub>	75	°C/W
	S1K S1M		85	°C/W

ELECTRICAL SPECIFICATIONS (T <sub>A</sub> = 25°C unless otherwise noted)					
PARAMETER	CONDITIONS	SYMBOL	ТҮР	MAX	UNIT
Forward voltage <sup>(1)</sup>	$I_F = 1A, T_J = 25^{\circ}C$	V <sub>F</sub>	-	1.1	V
Reverse current @ rated $V_R^{(2)}$	T <sub>J</sub> = 25°C	- I <sub>R</sub>	-	1	μA
	T <sub>J</sub> = 125°C		-	50	μA
Junction capacitance	1MHz, V <sub>R</sub> = 4.0V	CJ	12	-	pF
Reverse recovery time	$I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A$	t <sub>rr</sub>	1500	-	ns

#### Notes:

1. Pulse test with PW = 0.3ms

2. Pulse test with PW = 30ms

ORDERING INFORMATION				
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING		
S1x	DO-214AC (SMA)	7,500 / Tape & Reel		

Notes:

1. "x" defines voltage from 50V(S1A) to 1000V(S1M)



INSTANTANEOUS REVERSE CURRENT (µA)

### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

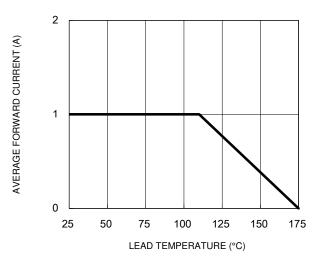
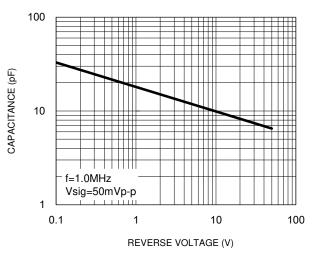


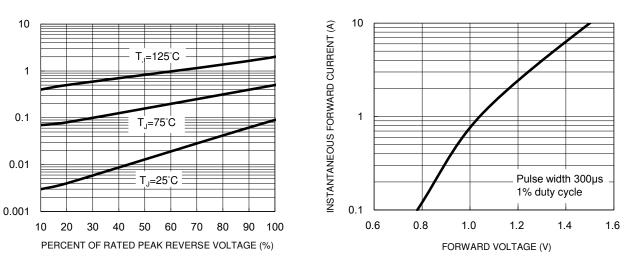
Fig.1 Forward Current Derating Curve

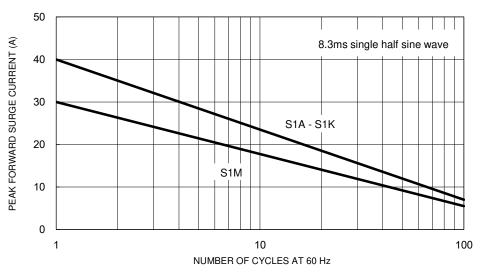
#### **Fig.3 Typical Reverse Characteristics**



#### **Fig.2 Typical Junction Capacitance**

**Fig.4 Typical Forward Characteristics** 



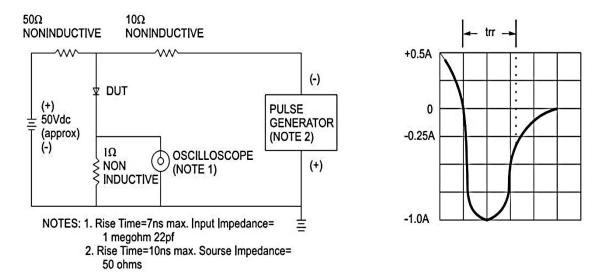


#### Fig.5 Maximum Non-Repetitive Forward Surge Current



### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

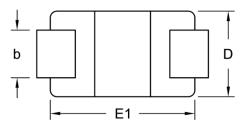


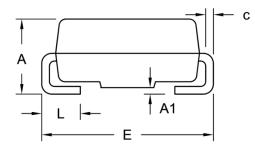
#### Fig.6 Reverse Recovery Time Characteristic And Test Circuit Diagram



## PACKAGE OUTLINE DIMENSIONS

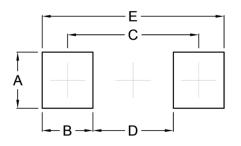
DO-214AC (SMA)





DIM.	Unit (mm)		Unit	(inch)
	Min.	Max.	Min.	Max.
A	1.99	2.50	0.078	0.098
A1	0.10	0.20	0.004	0.008
b	1.27	1.58	0.050	0.062
с	0.15	0.31	0.006	0.012
D	2.29	2.83	0.090	0.111
E	4.95	5.33	0.195	0.210
E1	4.06	4.60	0.160	0.181
L	0.90	1.41	0.035	0.056

## SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
A	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
E	5.45	0.215

### **MARKING DIAGRAM**



P/N	= Marking Code

G = Green Compound

YW = Date Code

F = Factory Code



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